

## SUBSTITUTE SPECIFICATION

METHOD AND DEVICE FOR READING DEEP BAR CODES  
BY WAY OF OPTICAL INTERFERENCEPRIOR APPLICATIONS

5     This application is a §371 U.S. National Phase patent  
application basing priority on International Application No.  
PCT/DE2004/000508, filed on March 13, 2004, which in turn bases  
priority on German Application No. DE 103 14 633.4, filed on  
April 1, 2003.

BACKGROUND OF THE INVENTION10     1. Field of the Invention

       The invention relates to a method for reading a bar code  
extending into the depth of a substrate by means of optical  
interference, the bar code being represented by an area with  
marks in the substrate which is partly transparent to  
15     electromagnetic radiation.

2. Description of the Prior Art

       A standard, usually printed bar code comprising a  
plurality of parallel lines or bars for machine readable  
article identification is generally known. A deep or depth bar  
20     code is understood to be one in which the bars are not arranged  
on or parallel to the marked substrate surface, but are instead  
perpendicular to the surface in different depth planes of the  
substrate material.

For an exemplified explanation, a partial volume of the substrate with a characteristic width D (e.g. edge length, diameter) and height H (perpendicular to the substrate surface) is considered as the marking area having the deep bar code.

5 The area can be subdivided into N layers of identical thickness dH in each case, so that  $N \cdot dH = H$ . Each individual layer may be marked or unmarked, and the mark at least consists of a change in the optical characteristics compared with the unmarked substrate influencing the backscattering or reflection  
10 of light in at least one, preferably non-ionizing spectral range. On determining the positions of the marked layers with a resolution better than the layer thickness dH, this gives a bar code of length N bits.

It is advantageous when using deep bar codes that it is  
15 possible to accommodate a larger number of deep bar codes on substrates having a limited surface, because an individual bar code only requires a cross-sectional surface of approximately  $D^2 < 1000 \mu\text{m}^2$ . This e.g. makes it possible to record additional sample or specimen information or a detailed  
20 analytical history on the sample or specimen substrate. If a plurality of deep bar codes are preferably positioned in juxtaposed manner in such a way that linear movements of the reader or substrate permit the sequential reading of the bar code, it is possible to store in simple manner and with limited

space a large data quantity (1000 deep bar codes per square  
~~millimetre~~ millimeter). The individual reading processes  
remain independent of one another. In particular, the deep bar  
codes can be recorded at different times and with different  
5 writing or recording devices.

Another advantage of deep bar codes is the increased  
security against manipulation. With the naked eye, a deep bar  
code appears in the visible range as a neutral "fuzzy spot".  
Unlike a conventional bar code, without a reader it cannot be  
10 detected and translated into a number string. Thus, at least  
suitable devices are needed for reading and writing in order to  
be able to carry out specific manipulations, which would often  
fail as a result of the cost involved.

Numerous different methods can be used for writing or  
15 recording such deep bar codes. It is e.g. possible to produce  
labels from a plurality of superimposed, glued film layers with  
a differing transparency or refractive index, the sequence of  
the transparency change containing the bar code. In the case  
of semiconductors or other crystal substrates, the bar code  
20 could be preset during the epitactic growth by a controlled  
modification of the material provided or the growth conditions.

A particularly interesting possibility for producing  
complete falsification-proof (because ~~unreproducible~~  
irreproducible) deep bar codes consists of introducing

scattered particles into a hardening, optically transparent matrix, e.g. cast resin. The once fixed, precisely measured distribution of the scattered particles in the marking area represents a unique code, which cannot be precisely copied by similar procedures. Possible uses of such unique "number plates" are in the non-interchangeable marking of equipment, whose movement and use scope is subject to strict controls, such as military vehicles and weapon systems.

So-called internal engraving with laser light is suitable for glass substrates. Using brief laser light flashes, precisely located volumes are damaged in a selectable depth beneath the glass surface in such a way that in said volumes the substrate significantly loses transparency. It is already possible to engrave symbols visible with the eye in the glass without the glass surface suffering. Uses of this technology are the marking and archiving of biological and medical specimen carriers, e.g. for high throughput screening (HTS), which must not be contaminated by deposits on an engraved surface.

Independently of the details of the recording process, the problem arises of rapidly reading out with limited apparatus costs a deep bar code recorded in a marking area on a substrate, and this also constitutes the problem of the present invention.

## SUMMARY OF THE INVENTION

5 This problem is solved by the features of Claim 1. The subclaims relate to advantageous developments and a device for performing the method.

Interferometers, which do not require moving parts, are particularly suitable for performing the method using a limited amount of equipment and, consequently, inexpensively.

10 A first suitable measuring method consists of a variant of optical coherence tomography (OCT), which is e.g. described in WO 02/084263. OCT systems were specially developed for depth-resolved structural examinations and normally operate according to the Michelson interferometer principle. Short coherence length light is irradiated into a specimen, and from different  
15 specimen layer depths is backscattered or reflected with a varying intensity. If e.g. the specimen surface is seen as the mirror of the reference arm in the Michelson interferometer, the backscattered or reflected light can be subdivided into specimen light and reference light and made to interfere in an  
20 analytical unit. From the resulting interference pattern, conclusions can be drawn regarding the travel time distribution of the specimen light and, therefore, the scattering or reflecting power of the different layer depths  $S(z)$  in the specimen.

The expert is aware of a second suitable method from DE 43 09 056 A1, which is also known as "spectral radar". Light from a broad band light source is scattered ~~in to~~ into the specimen in a plane with a spacing  $z$  from a reference plane ( $z=0$ ), and on it is superimposed backscattered light from the reference plane. There is, consequently, a constructive or destructive interference for a random, fixed spacing  $z$  of the planes as a function of which of the irradiated wavelengths  $\lambda$  is considered. If a plurality of planes with spacing from an interval  $[z_1, z_2]$  to the reference plane participates in the backscattering, the starting intensity  $I(\lambda)$  is to be considered as an integral over this interval. When using broad band light, e.g. from a superluminescence diode, the interference light is spectrally resolved and is normally imaged on a photodiode line or a comparable device. This permits the measurement of the distribution  $I(k)$ ,  $k=2\pi/\lambda$  as the spatial distribution on the sensor line. In a single calculating step, a Fourier transformation of this distribution leads to the depth-dependent scattering or reflecting power  $S(z)$ .

#### 20      DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENT

Said interferometers use a clearly defined plane of the specimen, i.e., the specimen surface, as the beam splitter and mirror for the reference light. On reading deep bar codes this is particularly preferred, because a support produced

specifically for this purpose, e.g. a label, can be provided easily with an optimum coating for this. However, in some cases it is advantageous to use a reference light mirror outside the support or substrate, such as in a special  
5 reference arm, into which the reference light is deflected by means of a beam splitter, or by using a partly reflecting window in the illuminating optics directed towards the substrate. Such constructions are appropriate if e.g. as a result of contamination, ~~ageing~~ aging or mechanical stress  
10 damage is to be expected to the substrate plane considered as the reference mirror.

As soon as the scattering power or reflectivity is available in digitized form as a function of the layer depth  $S(z)$ , the translation of this function by a transcription unit  
15 (computer with standard software) into a number string can be brought about in an obvious manner.

Modern interferometer tomographs are able to scan a marking range of up to 2 mm in the case of a layer resolution of 10  $\mu\text{m}$ . This leads to a theoretically attainable bar code  
20 length of 200 bits, which is clearly much higher than the necessary 95 bits of the ~~universal product code~~ Universal Product Code (UPC). No importance is attached to the precise position of the bar code in the substrate marking area or the characteristic marking area width  $D$ , which is oriented with

respect to the illuminating optics and need only be a few 10  
µm. The absolute spacing[s] dH of adjacent layers or bars in  
the marking area are also unimportant, provided that they do  
not drop below the resolution of the interferometric method  
5 used and remain constant within limited tolerances over the  
entire bar code. Using standard methods, there is no difficulty  
in programming the transcription unit in such a way that  
relative displacements and distortions of deep bar codes with  
respect to one another are automatically detected and correctly  
10 compensated.

A particular advantage of the method according to the  
invention is that even optically invisible security marks can  
be identified. On selecting a substrate material non-  
transparent in the visible spectrum, but which is partly  
15 transparent e.g. in the infrared, it is possible to read marks  
beneath the surface if it is ~~a-priori~~ prior known whether and  
where they are precisely present.